

L Number	Hits	Search Text	DB	Time stamp
1	369766	transparent or translucent	USPAT; US-PGPUB	2004/04/28 17:14
2	9779	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$))	USPAT; US-PGPUB	2004/04/28 17:14
4	1061	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?)	USPAT; US-PGPUB	2004/04/28 17:15
6	408	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)	USPAT; US-PGPUB	2004/04/28 17:15
8	187	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) and (semiconduct\$ or wafer? or chip?)	USPAT; US-PGPUB	2004/04/28 17:16
9	115	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) and (semiconduct\$ or wafer? or chip?) not (((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) and (semiconduct\$ or wafer? or chip?))	USPAT; US-PGPUB	2004/04/28 17:06
7	72	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) same (semiconduct\$ or wafer? or chip?)	USPAT; US-PGPUB	2004/04/28 16:48
10	76	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) same (front or frontside? same (back or backside?)	USPAT; US-PGPUB	2004/04/28 17:17
11	19	((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) and (semiconduct\$ or wafer? or chip?) not (((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) and (semiconduct\$ or wafer? or chip?)) and (((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$) same (front or frontside? same (back or backside?)	USPAT; US-PGPUB	2004/04/28 17:08

12	57	(((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?)) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) same (front or frontside?) same (back or backside?)) not (((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?)) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (semiconduct\$ or wafer? or chip?)) not (((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?)) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (semiconduct\$ or wafer? or chip?)) and (((transparent or translucent) same (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) same (front or frontside? or back or backside?)) same (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) same (front or frontside?) same (back or backside?))	USPAT; US-PGPUB	2004/04/28 17:10
13	333312	transparent or translucent	JPO; DERWENT	2004/04/28 17:14
14	5115	(transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)	JPO; DERWENT	2004/04/28 17:14
15	0	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)	USPAT; US-PGPUB	2004/04/28 17:16
16	0	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)	USPAT; US-PGPUB	2004/04/28 17:15
17	1934	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)	JPO; DERWENT	2004/04/28 17:28
18	529	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)	JPO; DERWENT	2004/04/28 17:16
19	221	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?))	JPO; DERWENT	2004/04/28 17:16
20	19	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (semiconduct\$ or wafer? or chip?)	JPO; DERWENT	2004/04/28 17:17
21	0	((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or anal\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)	USPAT; US-PGPUB	2004/04/28 17:17

22	78	(((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?))	JPO; DERWENT	2004/04/28 17:17
23	37	(((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)	JPO; DERWENT	2004/04/28 17:18
24	55	(((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?))) and (semiconduct\$ or wafer? or chip?) or (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$))	JPO; DERWENT	2004/04/28 17:28
25	474	(((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) not ((((((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?))) and (semiconduct\$ or wafer? or chip?) or (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)))	JPO; DERWENT	2004/04/28 17:28
26	166	(((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) not ((((((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?))) and (semiconduct\$ or wafer? or chip?) or (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)))) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)	JPO; DERWENT	2004/04/28 17:37

27	308	<p>(((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) not (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (semiconduct\$ or wafer? or chip?)) or (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) not (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) not (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (semiconduct\$ or wafer? or chip?)) or (((transparent or translucent) and (cmp or polish\$ or chemimech\$ or planariz\$ or lap\$ or grind\$ or abrad\$)) and (front or frontside? or back or backside?)) and (front or frontside?) and (back or backside?)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$)) and (protect\$ or warp\$ or bend\$ or microscop\$ or defect\$ or analy\$ or test or support\$ or bond\$ or adhes\$ or adher\$))</p>	JPO; DERWENT	2004/04/28 17:37
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